TOSHIBA BIPOLAR DIGITAL INTEGRATED CIRCUIT SILICON MONOLITHIC

## TD62786AP,TD62786F,TD62786AF TD62787AP,TD62787F,TD62787AF

#### 8CH HIGH-VOLTAGE SOURCE DRIVER

The TD62786AP / F / AF series are eight channel huyx non-inverting source current transistor array. All units feature integral clamp diodes for switching inductive loads. Applications include relay, hammer and lamp drivers.

#### **FEATURES**

High output voltage type-AP, AF :  $V_{CE}$  (SUS) = 50 V (Min)

type-F :  $V_{CE}$  (SUS) = 35 V (Min)

: IOUT = -500 mA / chOutput current (single output)

(Max)

Output clamp diodes

Single supply voltage

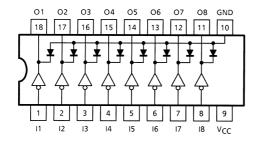
Input compatible with TTL, 5 V CMOS

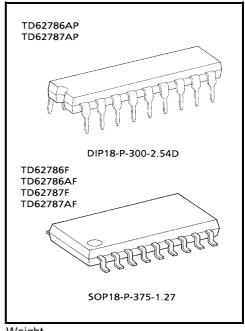
Low level active input

Package type-AP : DIP-18 pin

Package type-F, AF: SOP-18 pin

## PIN CONNECTION (TOP VIEW)

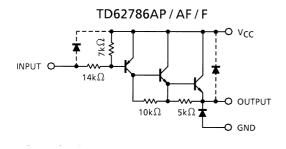


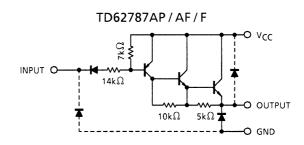


Weight

DIP18-P-300-2.54D: 1.47 g (Typ.) SOP18-P-375-1.27: 0.41 g (Typ.)

## **SCHEMATICS (EACH DRIVER)**





Note: The input and output parasitic diodes cannot be used as clamp diodes.



## MAXIMUM RATINGS (Ta = 25°C)

CHARACTER	RISTIC	SYMBOL	RATING	UNIT	
Supply Voltage	AP / AF	V <sub>CC</sub> -V <sub>GND</sub>	50	V	
Supply Voltage	F	VCC-VGND	35	v	
Output Sustaining Voltage	AP / AF	Vour	-50	V	
	F	V <sub>OUT</sub>	-35	v	
Output Current		lout	-500	mA / ch	
Input Voltage		V <sub>IN</sub> (Note 1)	-30~0.5	V	
Input Voltage		V <sub>IN</sub> (Note 2)	V <sub>GND</sub> ~7	V	
Clamp Diode Forward Current	AP / AF	V <sub>R</sub>	50	V	
	F	VR	35	V	
Clamp Diode Forward	Current	l <sub>F</sub>	500	mA	
Power Dissipation	AP	D- (Note 2)	1.47	W	
	F/AF	P <sub>D</sub> (Note 3)	0.96	VV	
Operating Temperature	•	T <sub>opr</sub>	-40~85	°C	
Storage Temperature		T <sub>stg</sub>	-55~150	°C	

Note 1: Only TD62786AP / F / AF Note 2: Only TD62787AP / F / AF

Note 3: Delated above 25°C in the proportion of 11.7 mW / °C (AP Type), 7.7 mW / °C (F, AF Type).

## RECOMMENDED OPERATING CONDITIONS (Ta = -40-85°C, $V_{CC} = 0 \text{ V}$ )

CHARACTERISTIC		SYMBOL	CONDITION	MIN	TYP.	MAX	UNIT
Supply Voltage	AP / AF	V <sub>CC</sub> -V <sub>GND</sub>	_	_	_	50	٧
	F		_	_	_	35	
Output Voltage	AP / AF	V <sub>OUT</sub>	_	_	_	-50	V
	F		_	_	_	-35	
Output Current		I <sub>OUT</sub>	_	-	_	-350	mA / ch
Input Voltage	TD62786	V <sub>IN</sub>	_	-30	_	0	٧
	TD62787		_	$V_{GND}$	_	7	
Clamp Diode Reverse Voltage	AP / AF	V <sub>R</sub>	_	_	_	50	V
	F		-	_	_	35	
Clamp Diode Forward Current		l <sub>F</sub>		_	_	350	mA
Power Dissipation	AP	P <sub>D</sub>	_	_	_	0.52	W
	AF/F		_	_	_	0.35	VV

2



## ELECTRICAL CHARACTERISTICS (Ta = 25°C, V<sub>CC</sub> = 0 V)

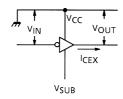
CHARACTERISTIC		SYMBOL	TEST CIR- CUIT	TEST CONDITION	MIN	TYP.	MAX	UNIT	
Output Leakage Current		I <sub>CEX</sub>	1	$V_{OUT} = V_{GND} = -50 \text{ V}$ Ta = 85°C	_	-	-100	μA	
Output Saturation Voltage		V-= ( ::	2	V <sub>IN</sub> = V <sub>IL</sub> MAX. I <sub>OUT</sub> = -100 mA	_	_	-1.8	· V	
		V <sub>CE</sub> (sat)		V <sub>IN</sub> = V <sub>IL</sub> MAX. I <sub>OUT</sub> = -350 mA	_	_	-2.0		
DC Current transfer Ratio		h <sub>FE</sub>	2	V <sub>CC</sub> = 0 V, V <sub>CE</sub> = 3 V I <sub>OUT</sub> = -350 mA	1000	_	_	_	
Input Voltage	"H" Level	TD62786	V <sub>IN</sub>	4	_	-1.2	_	0	· V
	n Level	TD62787				-1.6	_	5.5	
	"L" Level	TD62786				-30	_	-2.8	
		TD62787				$V_{GND}$	_	-3.7	
Input Current		I <sub>IL</sub>	_	V <sub>CC</sub> = 5.5 V, V <sub>IN</sub> = 0.4 V	_	_	-0.4	mA	
Clamp Diode Reverse Current		I <sub>R</sub>	_	$V_R = V_R$ $MAX.$ , $Ta = 85$ °C	_	_	100	μА	
					_	_			
Clamp Diode Forward Voltage		V <sub>F</sub>	_	_		_	2.0	V	
Turn-On Delay		t <sub>ON</sub>	5	$V_{OUT} = -50 \text{ V}, R_L = 163 \Omega$ $C_L = 15 \text{ pF}$ (Note)		0.2	_	2	
Turn Off Delay		t <sub>OFF</sub>			_	1.0	_	μs	

3

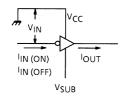
Note:  $V_{OUT}$  = -35 V,  $R_L$  = 116  $\Omega$  for Type-F

#### **TEST CIRCUIT**

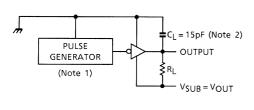
## 1. ICEX



## 3. I<sub>IN (ON)</sub>, I<sub>IN (OFF)</sub>



#### 5. ton, toff

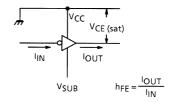


#### Note 1: Pulse Width 50 µs, Duty Cycle 10%

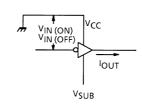
Output Impedance 50  $\Omega$ ,  $t_r \le 10$  ns,  $t_f \le 5$  ns

Note 2: C<sub>L</sub> includes probe and jig capacitance.

# V<sub>CE</sub> (sat), h<sub>FE</sub>



## VIN (ON), VIN (OFF)



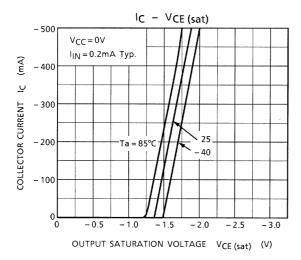
#### 50% 50% 10% 10% $V_{\mathsf{IL}}$ ton tOFF ۷он 50% 50% $V_{OL}$

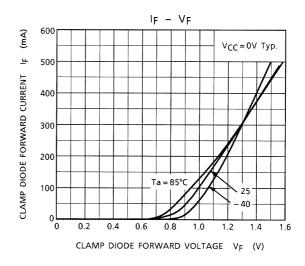
#### **PRECAUTIONS for USING**

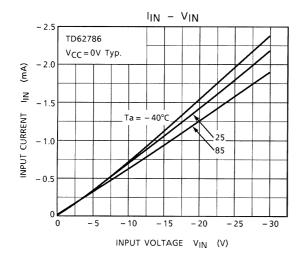
This IC does not integrate protection circuits such as overcurrent and overvoltage protectors.

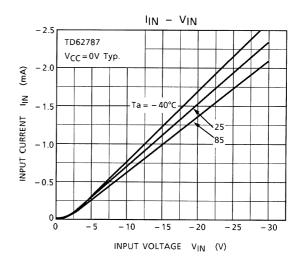
Thus, if excess current or voltage is applied to the IC, the IC may be damaged. Please design the IC so that excess current or voltage will not be applied to the IC.

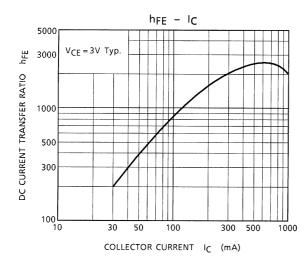
Utmost care is necessary in the design of the output line, VCC and GND line since IC may be destroyed due to short-circuit between outputs, air contamination fault, or fault by improper grounding.

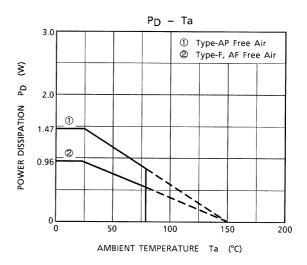








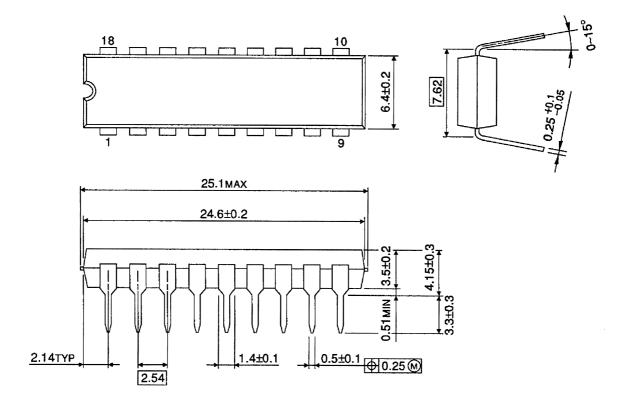




#### **PACKAGE DIMENSIONS**

DIP18-P-300-2.54D

Unit: mm

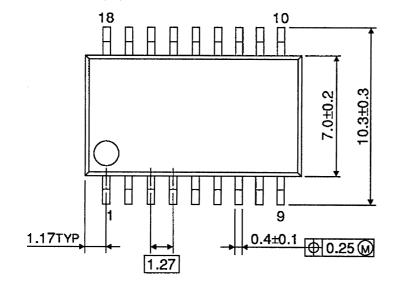


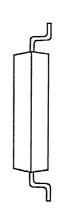
Weight: 1.47 g (Typ.)

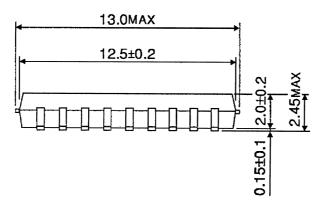
#### **PACKAGE DIMENSIONS**

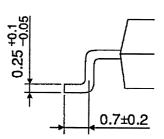
SOP18-P-375-1.27

Unit: mm









Weight: 0.41 g (Typ.)

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